



WP201208-ATC3

SMD Type White Emitter

Features

- Top view 0805 package
- Viewing Angle = $\pm 60^\circ$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright White
- RoHS compliance

Applications

- Optical indicator.
- Switch and Symbol Display.

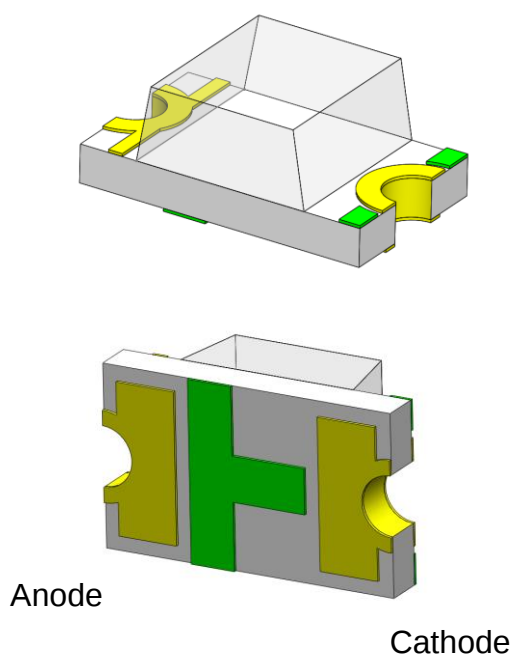
Description

The WP201208-ATC3 is an AlInGaN White LED housed in a miniature SMD package.

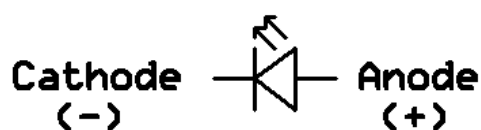
Static electricity and surge damage the LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs

Package Outline



Schematic





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Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
I _F	Continuous Forward Current	25	mA	
I _{FP}	Peak Forward Current	60	mA	1
V _R	Reverse Voltage	5	V	
T _{opr}	Operating Temperature	-40 ~ +85	°C	
T _{stg}	Storage Temperature	-40 ~ +100	°C	
T _{sol}	Soldering Temperature	260	°C	2
P _D	Power Dissipation at(or below) 25°C Free Air Temperature	95	mW	

Electro-Optical Characteristics *T_A = 25°C (unless otherwise specified)*

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
I _V	Luminous Intensity	I _F =20mA	565	-	1120	mcd	3
θ _{1/2}	Angle of Half Intensity	I _F =20mA	-	±60	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
V _F	Forward Voltage	I _F =20mA	3.0	-	3.4	V	4
I _R	Reverse Current	V _R =5V	-	-	1	μA	

Notes:

1. I_{FP} Conditions--Pulse Width ≤ 100μs and Duty ≤ 10%.
2. Soldering time ≤ 10 seconds.
3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
U2	565	715	mcd	I _F =20mA
V1	715	900		
V2	900	1120		

Tolerance of: Luminous Intensity ±10%



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4. Bin Range of Forward Voltage

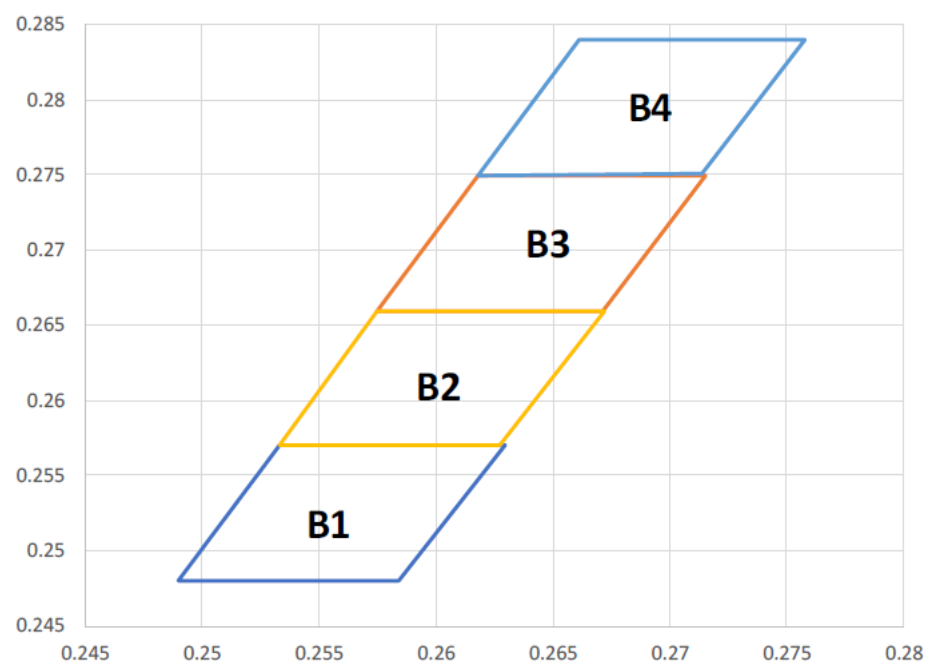
Bin Code	Min	Max	Unit	Condition
37	3.0	3.1	V	I _F =20mA
38	3.1	3.2		
39	3.2	3.3		
40	3.3	3.4		

Tolerance of Forward Voltage $\pm 0.05V$.

5. Bin Range of Chromaticity Coordinates

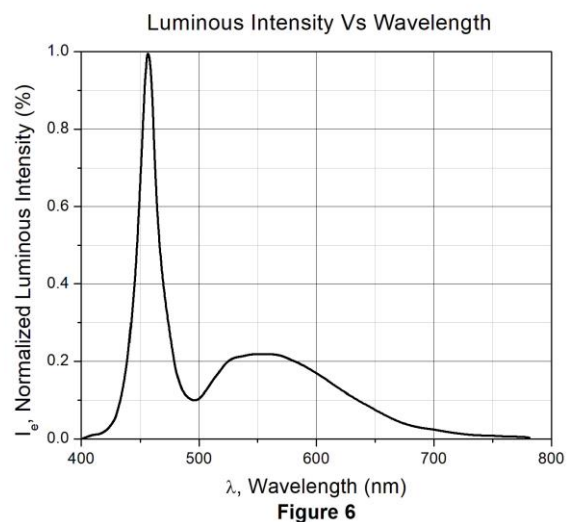
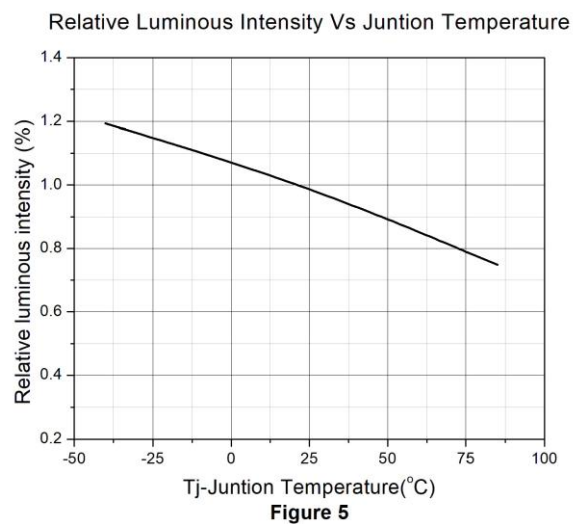
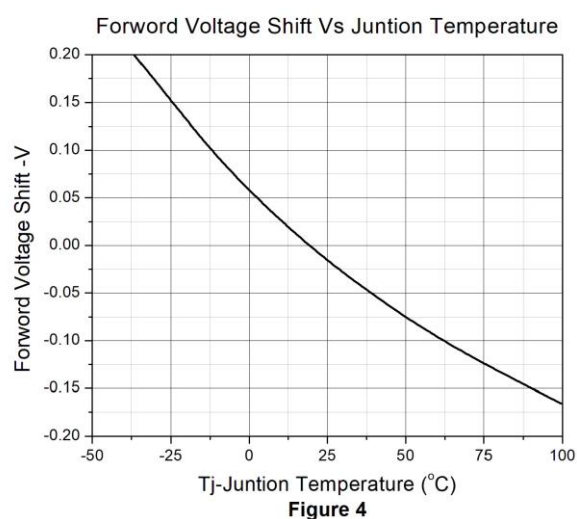
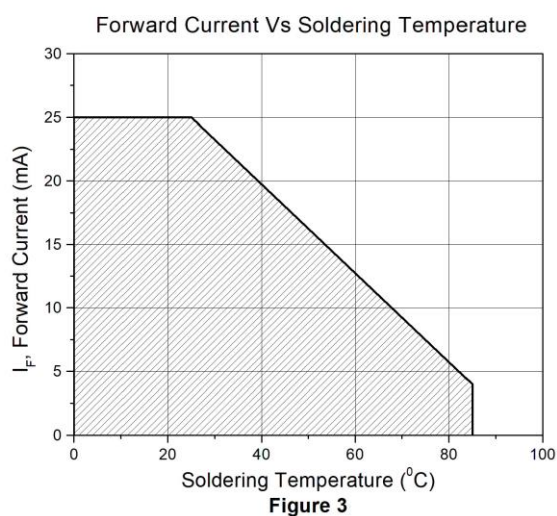
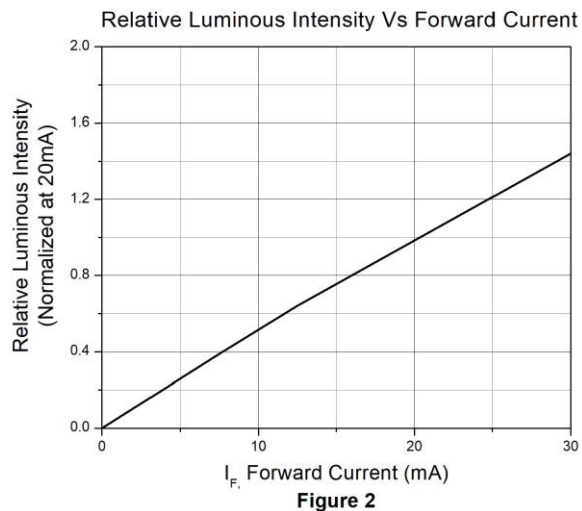
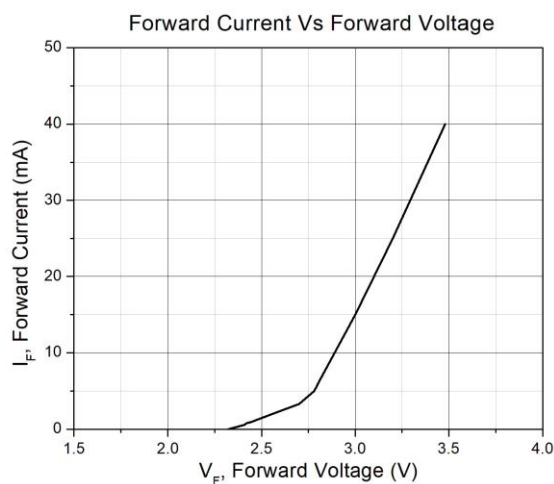
Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
B1	0.2490	0.2480	B2	0.2533	0.2570
	0.2533	0.2570		0.2575	0.2660
	0.2630	0.2570		0.2672	0.2660
	0.2584	0.2480		0.2627	0.2570
B3	0.2575	0.2660	B4	0.2618	0.2750
	0.2618	0.2750		0.2661	0.2840
	0.2715	0.2750		0.2758	0.2840
	0.2671	0.2660		0.2714	0.2751

The C.I.E 1931 Chromaticity Diagram



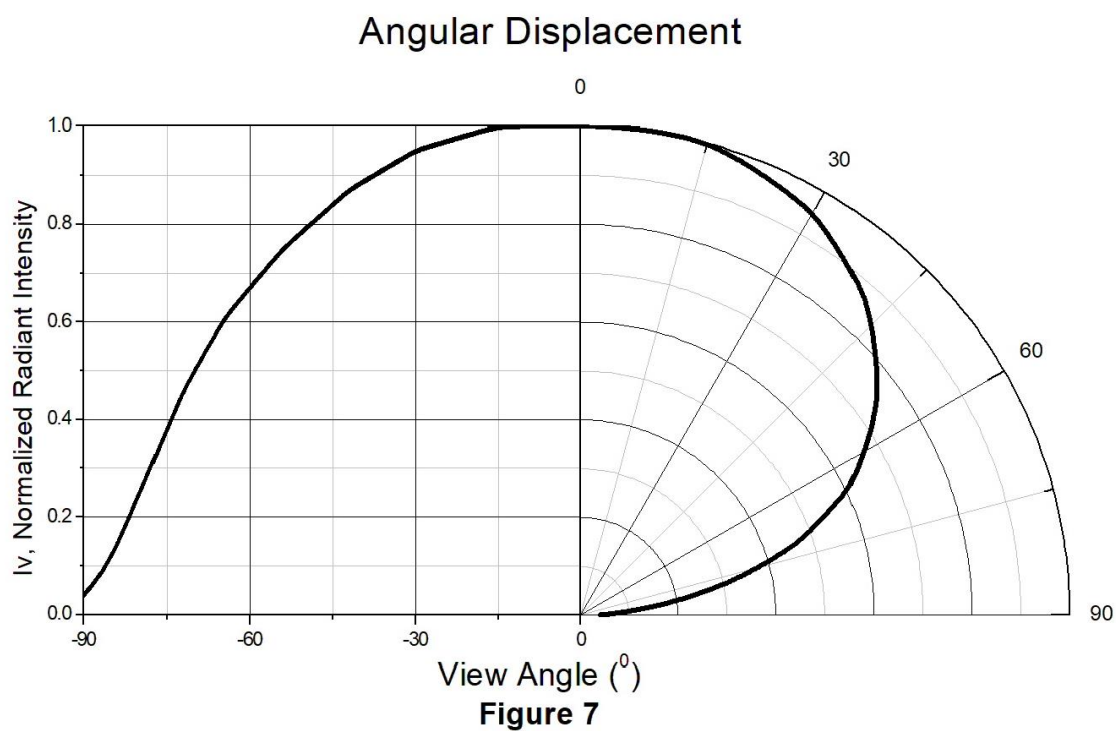


Typical Characteristic Curves





Typical Characteristic Curves

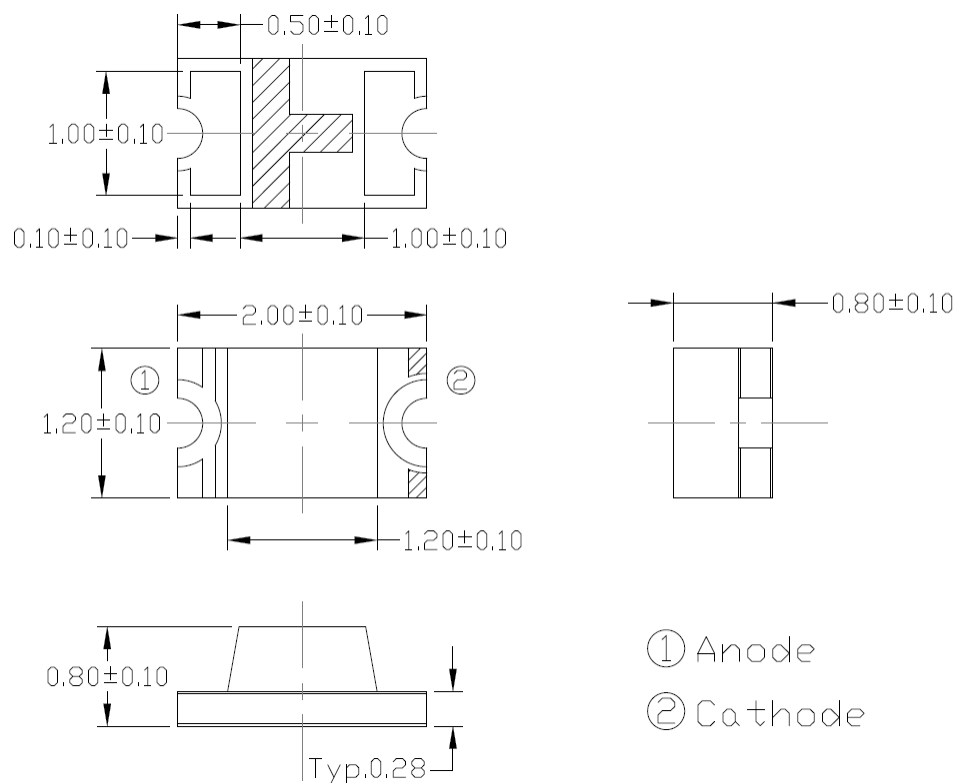




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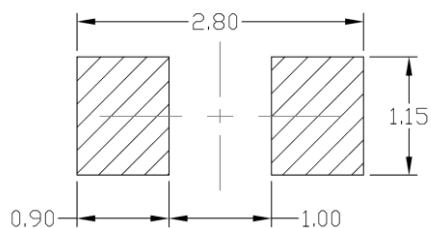
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Package Dimension *All dimensions are in mm, unless otherwise stated*



Note: Tolerance unless mentioned is ± 0.1 mm.

Recommended Soldering Mask *All dimensions are in mm, unless otherwise stated*



Note: Tolerance unless mentioned is ± 0.1 mm.

Ordering Information

Part Number	Description	Quantity
WP201208-ATC3	Tape & Reel	3000 pcs

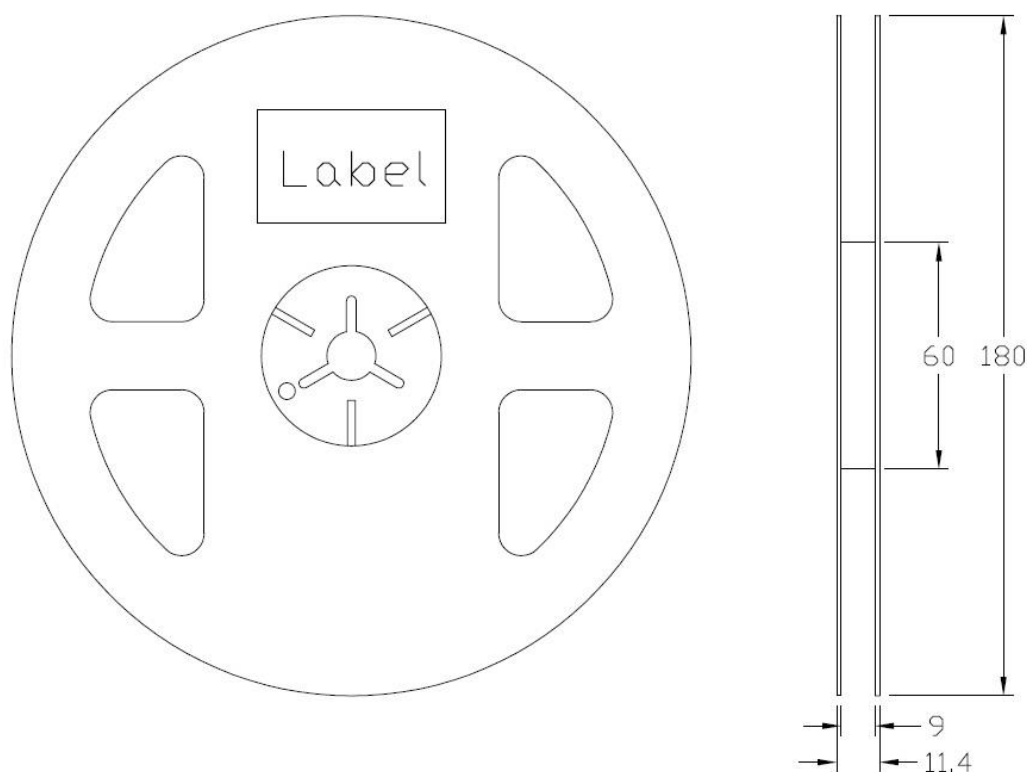


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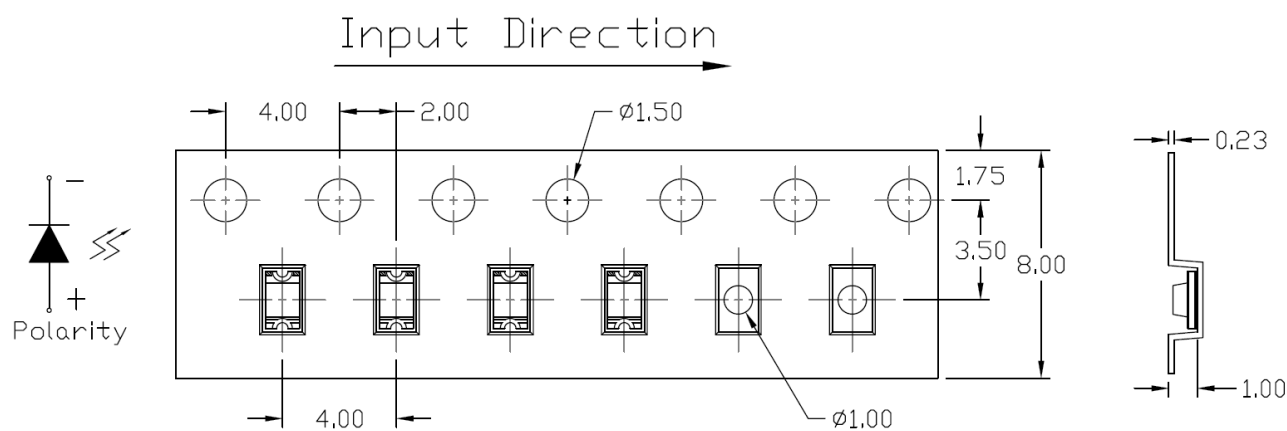
Reel Dimension

All dimensions are in mm, unless otherwise stated



Tape Dimension

All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is $\pm 0.1\text{mm}$.



Label Form Specification

CT Micro
International Corporation

MSL-X
MADE IN CHINA

CPN: XXXXXXXXXXXXXXXXX
|||||

Part no: XXXXXXXXXXXXX
|||||

Serial no: XXXXXXXX
|||||

Lot no: XXXXXXXX
|||||

Qty: XXXXXX Date Code: YWWJ
|||||

IV: XX WD:XX VF:XX
|||||

QR Code

Pb
RoHS

CPN : Customer Part Number

Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV : Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

MADE IN CHINA: Production Place

Storage Condition

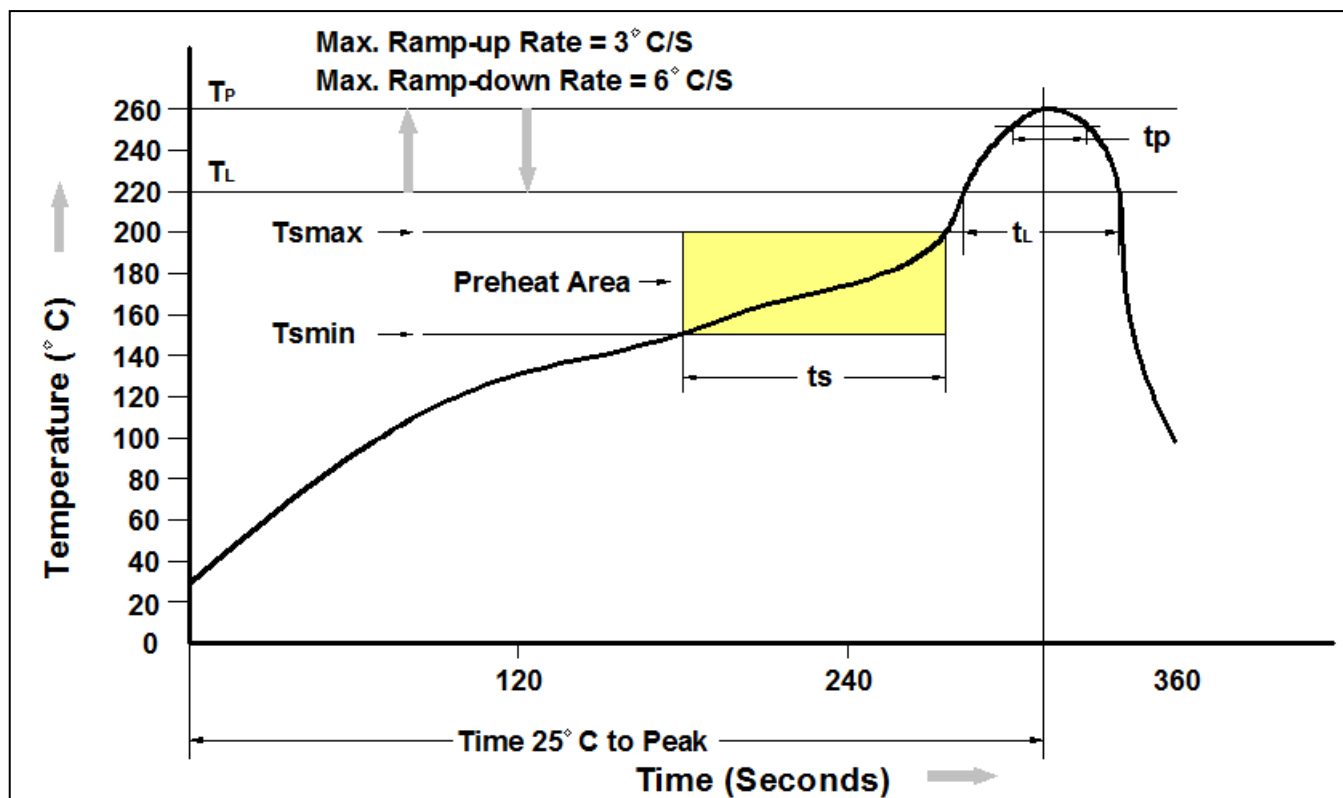
1. Do not open moisture proof bag before the products are ready to use.
2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening.
Shelf life of non-opened bag is 12 months after the bag sealing date.
3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



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Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.*